

MOS FIELD EFFECT TRANSISTOR 2SK3359

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3359 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- · Low on-state resistance
 - $R_{DS(on)1} = 20 \text{ m}\Omega$ MAX. (Vgs = 10 V, ID = 35 A)
- \bigstar RDS(on)2 = 28 m Ω MAX. (VGS = 4.5 V, ID = 30 A)
- ★ Low Ciss: Ciss = 4900 pF TYP.
 - Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3359	TO-220AB
2SK3359-S	TO-262
2SK3359-Z	TO-220SMD

(TO-220AB)

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	100	V
Gate to Source Voltage (Vps = 0 V)	VGSS(AC)	±20	V
Gate to Source Voltage (Vps = 0 V)	VGSS(DC)	+20, -10	V
Drain Current (DC)	ID(DC)	±70	Α
Drain Current (Pulse) Note1	D(pulse)	±280	Α
Total Power Dissipation (Tc = 25°C)	Рт	100	W
Total Power Dissipation (T _A = 25°C)	PT	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	50	Α
Single Avalanche Energy Note2	Eas	250	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

2. Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V



(TO-262)



(TO-220SMD)



THERMAL RESISTANCE

Channel to Case $R_{th(ch-C)}$ 1.25 °C/W Channel to Ambient $R_{th(ch-A)}$ 83.3 °C/W

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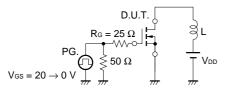
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

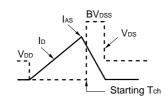


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

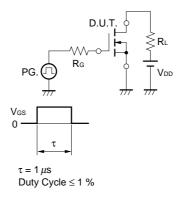
	CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Ib = 35 A		14	20	mΩ
*		RDS(on)2	Vgs = 4.5 V, ID = 30 A		19	28	mΩ
*	Gate to Source Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 \text{ V}, \text{ ID} = 250 \mu\text{A}$	1.5	2.0	2.5	V
	Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 35 A	23	47		S
	Drain Leakage Current	IDSS	V _{DS} = 100 V, V _{GS} = 0 V			10	μΑ
	Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
*	Input Capacitance	Ciss	V _{DS} = 10 V		4900		pF
	Output Capacitance	Coss	Vgs = 0 V		990		pF
	Reverse Transfer Capacitance	Crss	f = 1 MHz		580		pF
	Turn-on Delay Time	td(on)	ID = 35 A		58		ns
	Rise Time	t r	V _{GS(on)} = 10 V		400		ns
	Turn-off Delay Time	td(off)	V _{DD} = 50 V		340		ns
	Fall Time	t f	$R_G = 10 \Omega$		340		ns
	Total Gate Charge	Q _G	I _D = 70 A		130		nC
*	Gate to Source Charge	Qgs	VDD = 80 V		14		nC
*	Gate to Drain Charge	Q _{GD}	V _{GS(on)} = 10 V		50		nC
	Body Diode Forward Voltage	V _{F(S-D)}	IF = 70 A, VGS = 0 V		1.0		V
	Reverse Recovery Time	trr	IF = 70 A, Vgs = 0 V		170		ns
	Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		920		nC

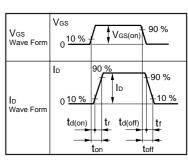
TEST CIRCUIT 1 AVALANCHE CAPABILITY



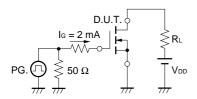


TEST CIRCUIT 2 SWITCHING TIME





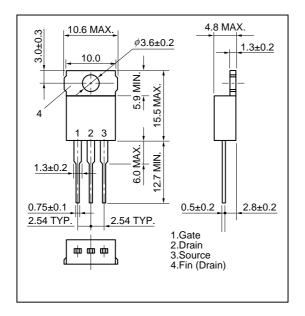
TEST CIRCUIT 3 GATE CHARGE



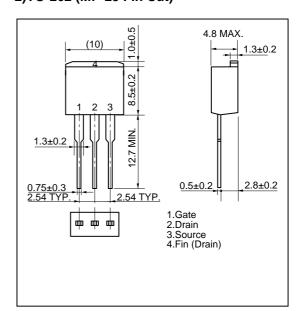


PACKAGE DRAWINGS (Unit: mm)

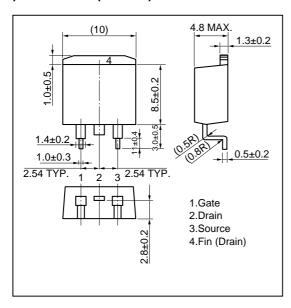
1)TO-220AB (MP-25)



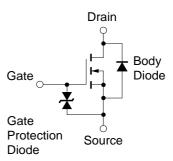
2)TO-262 (MP-25 Fin Cut)



3)TO-220SMD (MP-25Z)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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